IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of.:

Yair EIN-ELI et al

Serial No.:

10/551,714

Filed:

July 20, 2006

For:

COPPER CMP SLURRY

COMPOSITION

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Attorney Docket:

Group Art Unit:

30579

1793

Examiner:

Pegah Parvini

Mail Stop: Amendment Commissioner for Patents P.O. Box 1450

Alexandria, VA 22313-1450

ELECTION

Sir:

This is in response to the United States Patent and Trademark Restriction Office Action mailed December 5, 2008, which response is being made on or before January 5, 2009, and for which no extension of time fee is due.

Applicants hereby elect Group I, namely Claims 1-36 and 53, drawn to a composition useful for the formation of a passivating layer on a substrate.

Applicants reserve the right to file, at a later date, additional divisional applications claiming priority from the present application which are directed to the non-elected Groups.

Respectfully submitted,

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Date: January 1, 2009